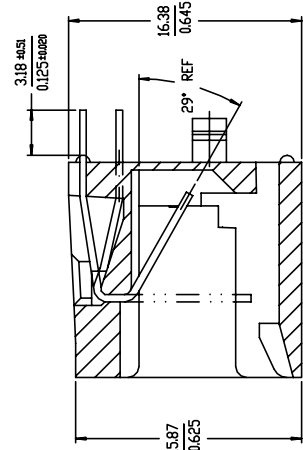
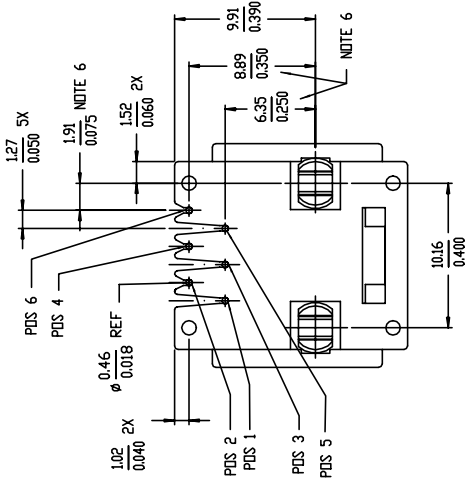
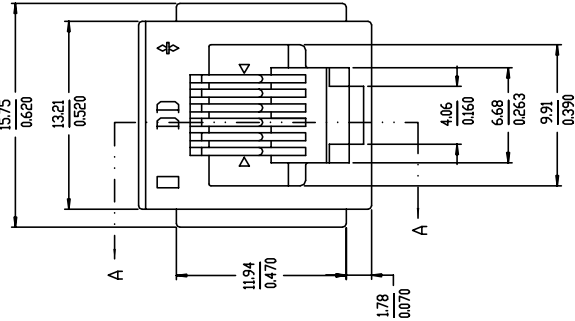
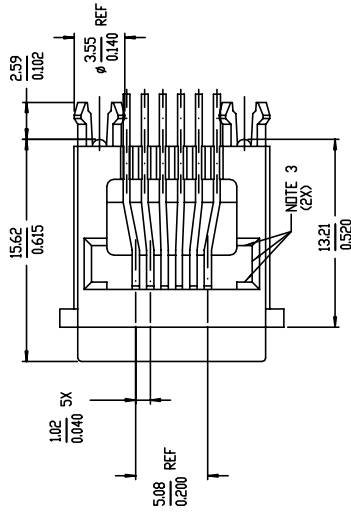


PRODUCT NO  
SEE CHART



SECTION A-A

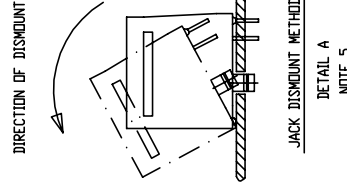
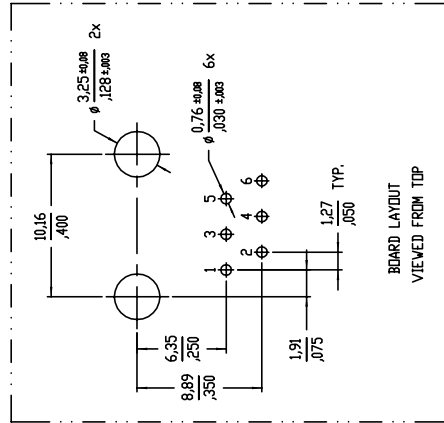
mat'l. code	surface	tolerance	projection	product family
ISD1302	ISD1001	ISD1001	ISD1001	MOD JACK
tr/ecn n/dtr date	tolerances unless otherwise specified			
N N04-0102 YS 11/23/04	angle	0.X±0.3	mm	
P N08-0097 SH 09/25/08	scale	0.XX±0.15	scale 2.0	6 POS VERT. SNAP PEG
R N08-0170 SH 10/10/08	dr	0.XXX±0.05		PCB III MOD JACK ASSY
S EX-N-0071 SH 03/14/12	enr	M CHENG	7/13/01	awg no
	chr	M CHENG	7/13/01	sheet of 2
	appd	J HSIA	7/20/01	A4
sheet revisions	S			type
index	Sheet 1	2		Product Customer Drawing
				90512



A

B

PRODUCT NO.	POSITIONS LOADED	CONTACT PLATING	NOTES
90512-101 -101LF -101F	ALL	5u" Au + high performance lubricant	BLACK
-102LF -102F	ALL	5u" Au + high performance lubricant	BLACK
-103LF -103F	2,3,4,5	5u" Au + high performance lubricant	BLACK
-104LF -104F	2,3,4,5	50u" / 127u GXT	BLACK
-105LF -105F	3,4	5u" Au + high performance lubricant	BLACK
-106LF	ALL	5u" Au + high performance lubricant	GREY
-107LF	ALL	5u" Au + high performance lubricant	GREY
-108LF	3,4	5u" Au + high performance lubricant	GREY



NOTES :

- 1 P/NO WITH DASH 0XX -NORMAL WAVE SOLDERING APPLICATION.  
P/NO WITH DASH 1XX -IR REFLOW APPLICATION (NOT TOOLED).
- 2 PACKAGING SPEC. BUS-14-164.
- 3 SCRATCH MARKS ACCEPTABLE ON THESE SURFACES.
- 4 JACK IS FOR 1.57/.062 THICK PCB.
- 5 SHOULD THE JACK NEED TO BE DISMOUNTED FROM THE PCB, PLS REMOVE JACK AS PER RECOMMENDED METHOD HEREIN. (DETAIL A) NIPPING THE LEGS OF THE PEG TOGETHER IS DISALLOWED, OTHERWISE LEG BREAKAGE MAY OCCUR.
- 6 THESE DIMENSIONS ARE TAKEN FROM THE TOP OF THE PEG.
- 7 THE PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS-22-008.
- 8 THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE FOR 10 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.60mm MINIMUM THICK CIRCUIT BOARD.
- 9 IF LF P/N PACKAGING MEETS GS-14-920 SPECIFICATION, EQUIVALENT THICKNESS Au AND GXT PLATING HAVE SAME FUNCTION AND THEY ARE ALTERNATIVE BY THE CUSTOMER.

LEAD FREE PRODUCT NO.

0- MEETS WAVE SOLDER PROCESS PRODUCT NO.  
1- MEETS PTP PROCESS PRODUCT NO.

PRODUCT NO.	POSITIONS LOADED	CONTACT PLATING	REMARKS
90512-101 -101LF -101F	ALL	5u" Au + high performance lubricant	NOT TOOLED
-102LF -102F	ALL	5u" Au + high performance lubricant	NOT TOOLED
-103LF -103F	2,3,4,5	5u" Au + high performance lubricant	NOT TOOLED
-104LF -104F	2,3,4,5	50u" / 127u GXT	NOT TOOLED
-105LF -105F	3,4	5u" Au + high performance lubricant	NOT TOOLED

mat'l. code		surface	tolerance	projection	product family
IS01302	IS0101 IS0406	tolerances unless otherwise specified	mm	MOD JACK	
trtecn naddr	date	angle	scale	title	
N 004-0102	YS 11/23/04	0.0	0.X±0.3	6 POS VERT. SNAP PEG	
P 008-0097	SH 09/25/08	0.0	0.XXX±0.15	PCB III MOD JACK ASSY	
R 008-0170	SH 10/10/08	0°±2'	0.XXX±0.05	dwg no sheet2of2 size	
S ELX-N-010713	SH MM 3/14/12	dr	M CHENG	90512 A4	
		engr	M CHENG	Product Customer Drawing	
		chr	M CHENG		
		appd	J HSM		
sheet	revision				
index	sheet				